

C1A-T1 AT Crystal 8 MHz - 30 MHz



DIMENSIONS Package: Recommended Solder Pad: 8,0 1,2 2,7 4,0 1,2 3,7 All dimensions in mm typical

SMT ceramic package height 1.75 mm Fundamental mode up to 30MHz Ind. and Ext. temperature ranges High stability and low aging High shock and vibration resistance Hermetically sealed **Ultra low MSL Excellent solderability** Swiss made quality **Customer specification on request**

DESCRIPTION:

This quartz Crystal in SMD ceramic package has been specially designed with Micro Crystal photolitographic process for surface mount using infrared, vapor phase or epoxy technics

APPLICATIONS:

- Avionics
- Radio transceiver
- Satellite communications
- Airborne equipments

The crystals are supplied in trays (100 crystals per tray).

For pick-and-place equipment, the parts are available in 16mm tapes:

7" with 1'000 crystals 10" with 2'000 crystals

ELECTRICAL CHARACTERISTICS AT 25°C:

Frequency Range		FL	8–30	MHz
Load capacitance	1)	CL	20.0	pF
Frequency tolerance at +25°C	2)	ΔF/F	+/-50	ppm
Frequency versus temperature TB: -40 to +85°C TC: -55 to +125°C	3)	ΔF/F ₀	+/-50 +/-100	ppm
Drive level typ/max		Р	100 / 500	μW
Insulation resistance min.		R _i	500	МΩ
Aging first year max.		ΔF/F	+/-3	ppm

- 1) Other load capacitances on request.
- 2) Tighter and wider frequency tolerances on request.
- 3) Tighter thermal stability on request.

Frequency [MHz]	Rs[Ω] typ / max	C1 [fF] typ / max	Co [pF] typ
8 to < 10	60 / 100	4/7	2
10 to < 12	50 / 85	5/8	2.2
12 to < 16	40 / 75	6 / 10	2.5
16 to < 20	35 / 60	8 / 11	2.8
20 to < 24	30 / 50	9 / 13	3.2
24 to ≤ 30	30 / 40	11 / 15	4

STANDARD FREQUENCIES:

Frequency MHz						
8.0000	10.0000	10.1506	11.0592	12.0000	12.288	13.56
14.3181	14.7456	16.0000	16.3840	18.432	20.0000	24.0000
Other frequencies from 8 MHz up to 30 MHz on request						

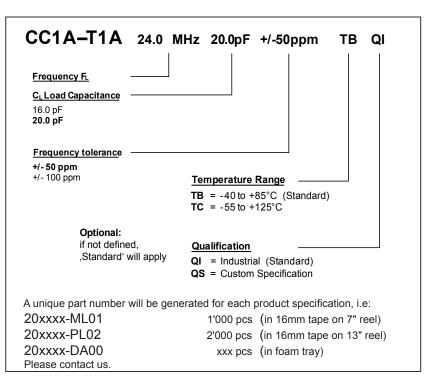
ENVIRONMENTAL CHARACTERISTICS:

	Conditions
Storage temp. range	−55 to +125°C
TB Operating temperature range	−40 to +85°C
TC Extended oper. temp. range	–55 to +125°C
Shock resistance	5000 g, 0.3 ms, ½ sine
Vibration resistance	20 g / 10–2000 Hz

TERMINATIONS AND PROCESSING:

Туре	Termination	Processing
CC1A-T1A	For SMD mounting Au plated pads	Reflow soldering +260°C / 20 s max.
CC1A-T3A	For SMD mounting Sn/Ag/Cu plated	Reflow soldering +260°C / 20 s max.

PRODUCT DESCRIPTION AND ORDERING INFORMATION:



All specifications subject to change without notice.



Micro Crystal AG Mühlestrasse 14 CH-2540 Grenchen Switzerland Tel. +41 32 655 82 82 Fax +41 32 655 82 83 sales@microcrystal.com www.microcrystal.com